Cooling paste | 1 pcs | ≥4.63W/m-k | Silver

General information

This Nedis® cooling paste is very heat conductive. It fills in all those microscopic imperfections on the heatsink and CPU/GPU that can trap air in them and cause a loss in the heatsink’s performance. The cooling paste ensures an outstanding heat conduction and dissipation. This allows you to run heavy programs without the motherboard getting overheated.

Features

• High stability and reliability
• Suitable to be applied to CPU, UPS, inverter, chipset and other PC components
• Low thermal resistance, high conductivity for heat transfer

Specifications

Colour:	Silver
Content:	1 pcs
Height:	14 mm
Type:	Paste
Moment beared temperature:	-50-300 °C
Operating temperature:	-30-280 °C
Specific gravity:	≥3.15
Thermal conductivity:	≥4.63W/m-k
Thermal impedance:	≤0.0087 °C-in²/W
Thixotropic index:	280 ± 10
Viscosity:	12500
Weight:	8 g
Depth:	114 mm
Width:	22 mm

Package contents



Sales information

Order code:	**COOLP400SI**
Product description:	Cooling paste | 1 pcs | ≥4.63W/m-k | Silver
Packaging:	Blister
Brand name:	Nedis

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Quantity	LxWxH (mm)		Weight	
1	95 mm	20 mm	185 mm	24 g
20	210 mm	125 mm	330 mm	580 g
40	270 mm	235 mm	350 mm	1660 g


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